

P-Channel MOSFET

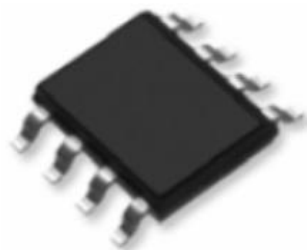
$BV_{DSS}, T_A=25^{\circ}\text{C}$	$I_D, T_A=25^{\circ}\text{C}$	$R_{DS(on)}, \text{typ}@-10\text{V}$
-40V	-22A	12mΩ

Features

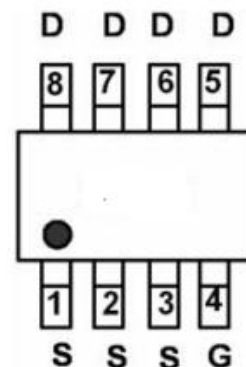
- Advanced trench cell design
- High speed switch
- $BV_{DSS} \geq -40\text{ V}$
- $R_{DS(on)} \leq 15\text{ m}\Omega @ V_{GS} = -10\text{ V}$
- $R_{DS(on)} \leq 21\text{ m}\Omega @ V_{GS} = -4.5\text{ V}$

Applications

- Portable appliances
- Battery management



SOP-8 top view



Absolute Maximum Ratings($T_A=25^{\circ}\text{C}$, unless otherwise noted.)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	V_{DS}	-40	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ^(note 1)	I_D	-22	A
Operating Junction Temperature Range	T_J	-55~150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55~150	$^{\circ}\text{C}$

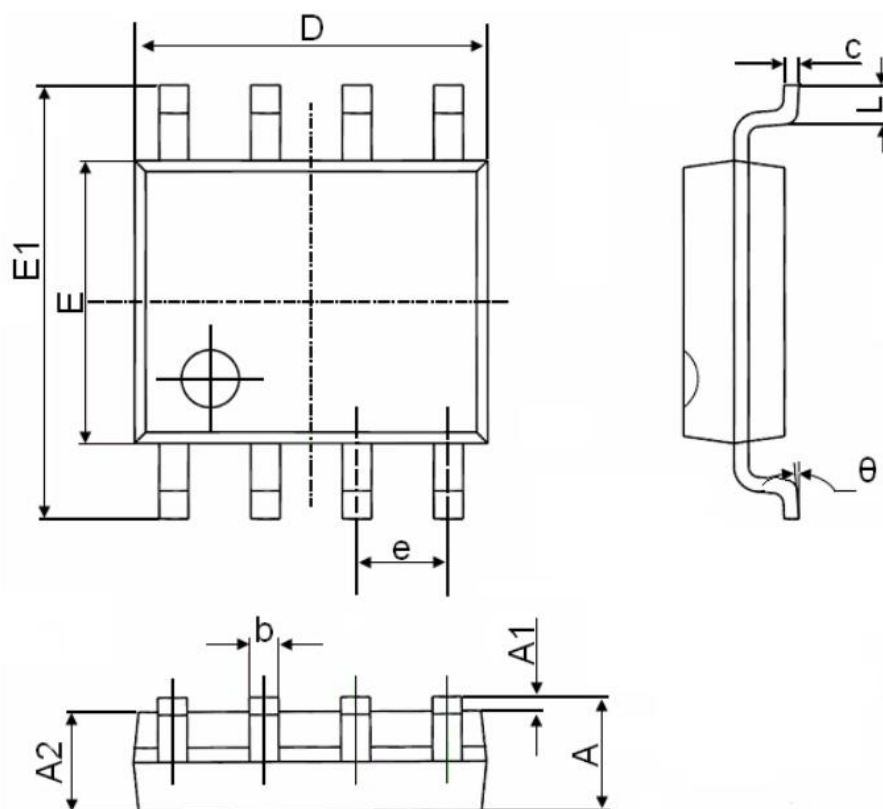
Electrical Characteristics($T_A=25^{\circ}\text{C}$, unless otherwise noted.)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-source Breakdown voltage	BV_{DSS}	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-32\text{V}, V_{GS}=0\text{V}$			-1	μA
		$V_{DS}=-32\text{V}, V_{GS}=0\text{V}, T_J=85^{\circ}\text{C}$			-30	μA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$			± 100	nA
Gate Threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1.0	-1.5	-2.0	V
Static Drain to Source on resistance	$R_{DS(on)}$	$V_{GS}=-10\text{V}, I_D=-1\text{A}$		12	15	mΩ
		$V_{GS}=-4.5\text{V}, I_D=-1\text{A}$		16	21	mΩ
Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=-0.5\text{A}$		-0.7	-1.3	V

Package Information

SOP-8

Dimensions in mm



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°